

Amendments to the Claims:

The following listing of claims will replace all prior versions, and listings, of claims in the application:

1. (Original) An insulating sheet comprising:
a buffer layer having buffering attributes;
an adhesive layer that is not adhesive at normal ambient temperature but exhibits adhesiveness when heated; and
an insulating resin film, wherein the buffer layer and the resin film are attached together by the adhesive layer.
2. (Original) The insulating sheet according to claim 1, wherein the adhesive layer is formed of resin that does not contain a silicone component.
3. (Original) The insulating sheet according to claim 1, wherein the resin film is formed from polyethylene terephthalate.
4. (Original) The insulating sheet according to claim 1, wherein the buffer layer is formed of urethane foam.
5. (Currently Amended) A hard disk ~~device~~comprising: device comprising:
a case for housing a hard disk;
a printed wiring board provided with a circuit for controlling the hard disk; and
an insulating sheet interposed between the printed wiring board and the case, wherein the insulating sheet comprises
a buffer layer having buffering attributes,
an adhesive layer that is not adhesive at normal ambient temperature but exhibits adhesiveness when heated, and
an insulating resin film, wherein the buffer layer and the resin film layer are attached together by the adhesive layer.

6. (Original) The hard disk device according to claim 5, wherein the adhesive layer is formed of resin that does not contain a silicone component.

7. (Original) The hard disk device according to claim 5, wherein the resin film is formed from polyethylene terephthalate.

8. (Original) The hard disk device according to claim 5, wherein the buffer layer is formed of urethane foam.

9. (Canceled)